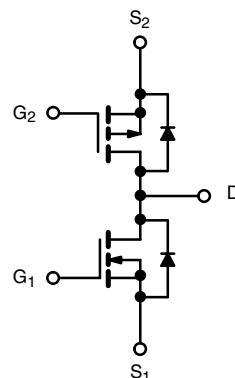
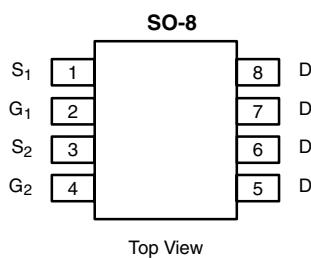


# Complementary MOSFET Half-Bridge (N- and P-Channel)

PRODUCT SUMMARY			
	V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
N-Channel	20	0.020 at V <sub>GS</sub> = 4.5 V	9.1
		0.030 at V <sub>GS</sub> = 2.5 V	7.5
P-Channel	- 20	0.060 at V <sub>GS</sub> = - 4.5 V	- 5.3
		0.100 at V <sub>GS</sub> = - 2.5 V	- 4.1

## FEATURES

- TrenchFET® Power MOSFET



ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted						
Parameter	Symbol	N-Channel		P-Channel		Unit
		10 sec	Steady State	10 sec	Steady State	
Drain-Source Voltage	V <sub>DS</sub>		20		- 20	
Gate-Source Voltage	V <sub>GS</sub>		± 12		± 12	V
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a,b</sup>	I <sub>D</sub>	9.1	6.6	- 5.3	- 3.8	A
		7.3	5.3	- 4.9	- 3.1	
Pulsed Drain Current	I <sub>DM</sub>	30		- 20		
Continuous Source Current (Diode Conduction) <sup>a,b</sup>	I <sub>S</sub>	2.1	1.1	- 2.1	- 1.1	
Maximum Power Dissipation <sup>a,b</sup>	P <sub>D</sub>	2.5	1.3	2.5	1.3	W
		1.6	0.8	1.6	0.8	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ	Max	Typ	Max	
Maximum Junction-to-Ambient <sup>a</sup>	R <sub>thJA</sub>	40	50	41	50	°C/W
		75	95	75	95	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	20	22	23	26

Notes:

- a. Surface Mounted on FR4 Board.
- b. t ≤ 10 sec.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

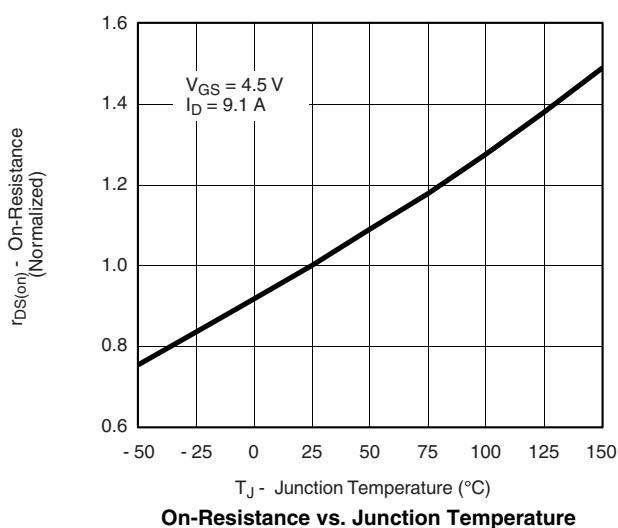
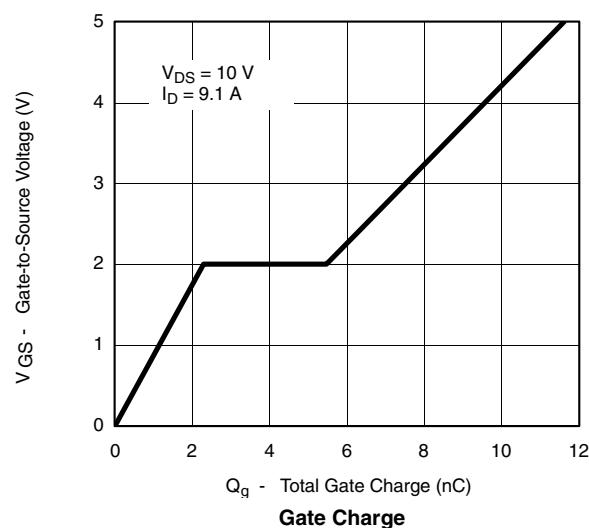
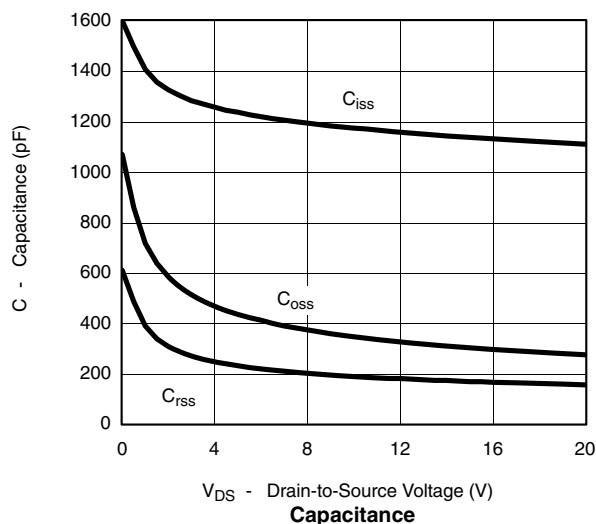
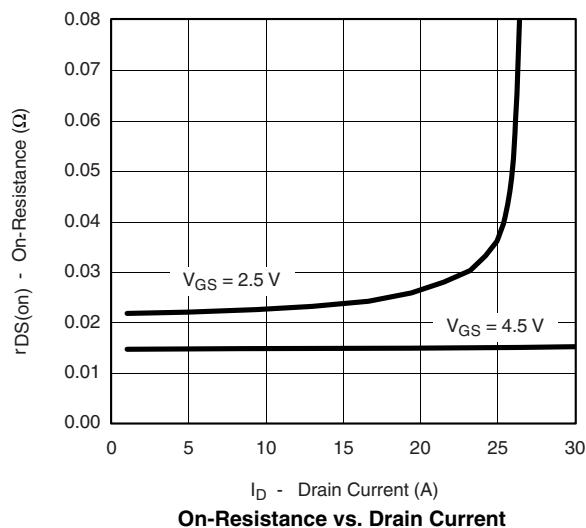
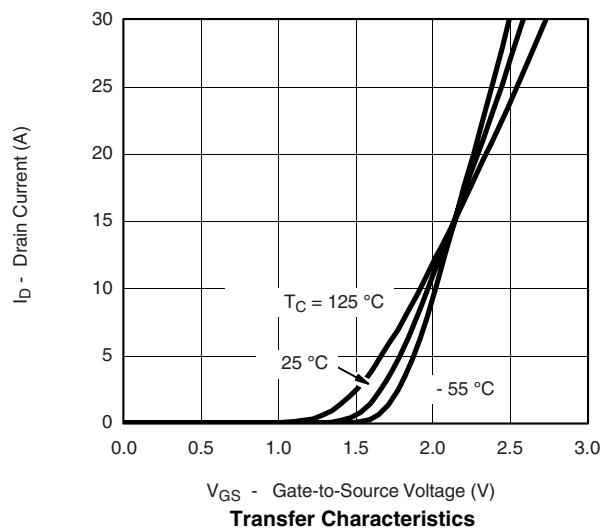
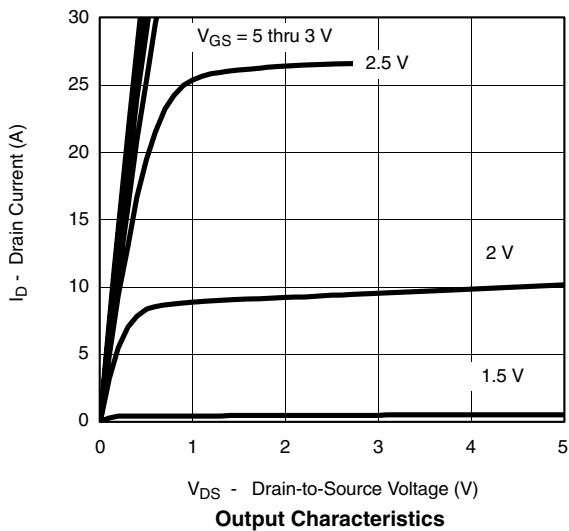
Parameter	Symbol	Test Conditions		Min	Typ <sup>a</sup>	Max	Unit
<b>Static</b>							
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	N-Ch	0.6		1.5	V
		$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	P-Ch	- 0.6		- 1.5	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	N-Ch			$\pm 100$	nA
			P-Ch			$\pm 100$	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1		$\mu\text{A}$
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	N-Ch		5		
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	P-Ch			- 5	
On-State Drain Current <sup>b</sup>	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	30			A
		$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 20			
Drain-Source On-State Resistance <sup>b</sup>	$r_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 9.1 \text{ A}$	N-Ch		0.016	0.020	$\Omega$
		$V_{GS} = -4.5 \text{ V}, I_D = -5.3 \text{ A}$	P-Ch		0.048	0.060	
		$V_{GS} = 2.5 \text{ V}, I_D = 3.3 \text{ A}$	N-Ch		0.024	0.030	
		$V_{GS} = -2.5 \text{ V}, I_D = -1 \text{ A}$	P-Ch		0.082	0.100	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 9.1 \text{ A}$	N-Ch		29		S
		$V_{DS} = -15 \text{ V}, I_D = -5.3 \text{ A}$	P-Ch		11		
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$I_S = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch		0.8	1.2	V
		$I_S = -2.1 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch		- 0.8	- 1.2	
<b>Dynamic<sup>a</sup></b>							
Total Gate Charge	$Q_g$	N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 9.1 \text{ A}$	N-Ch		11	17	nC
Gate-Source Charge	$Q_{gs}$		P-Ch		6.0	9	
Gate-Drain Charge	$Q_{gd}$		N-Ch		2.5		
Gate-Drain Charge	$Q_{gd}$		P-Ch		1.3		
Turn-On Delay Time	$t_{d(\text{on})}$	N-Channel $V_{DD} = 10 \text{ V}, R_L = 10 \Omega$ $I_D \approx 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$	N-Ch		3.2		ns
Rise Time	$t_r$		P-Ch		1.6		
Turn-Off Delay Time	$t_{d(\text{off})}$		N-Ch		35	50	
Fall Time	$t_f$		P-Ch		20	30	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 2.1 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$	N-Ch		50	80	ns
		$I_F = -2.1 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$	P-Ch		35	60	

Notes:

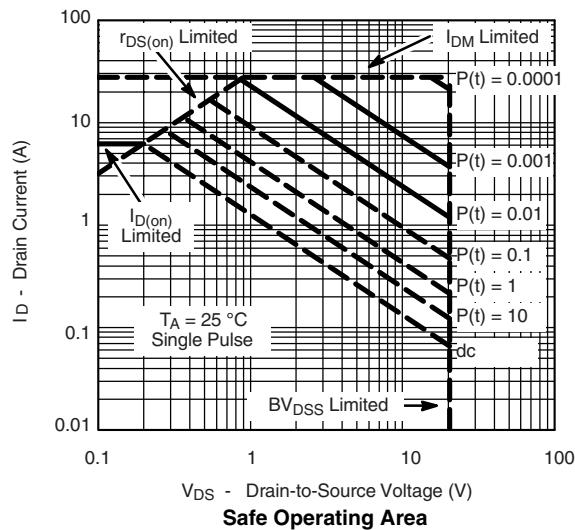
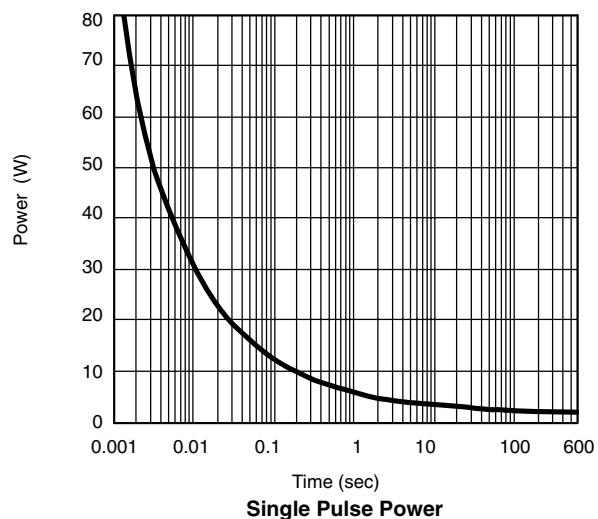
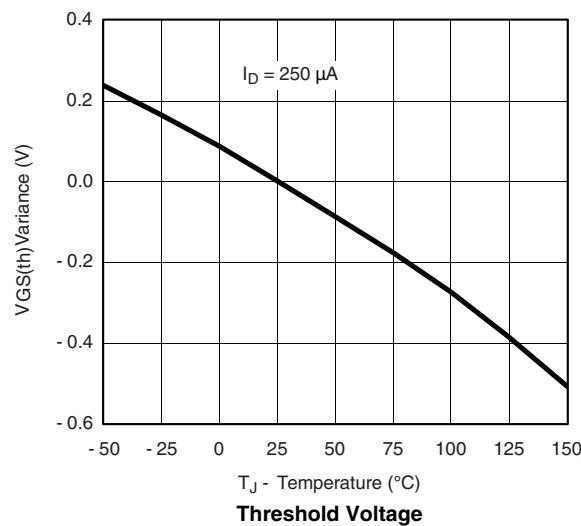
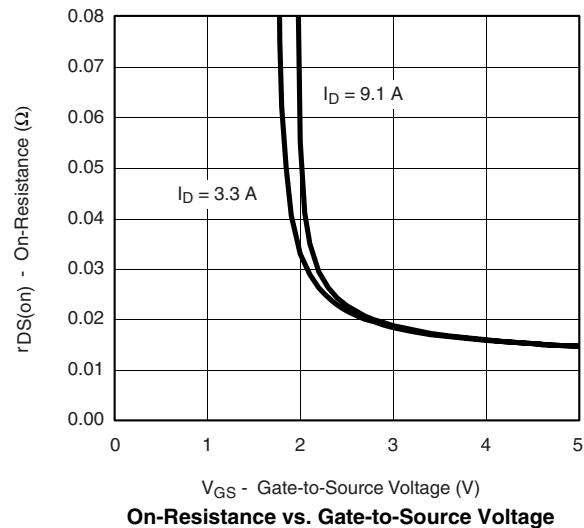
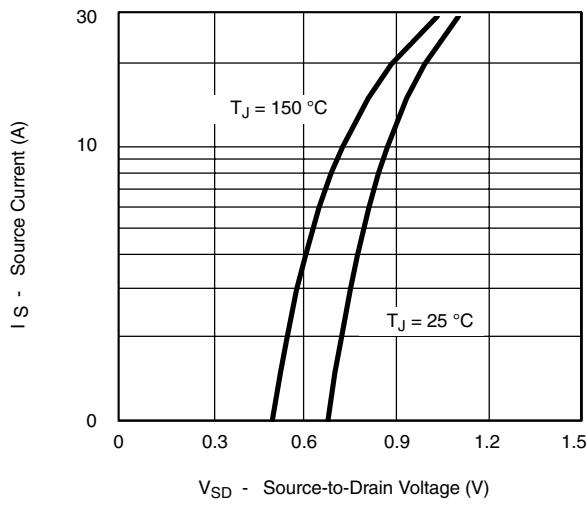
a. Guaranteed by design, not subject to production testing.

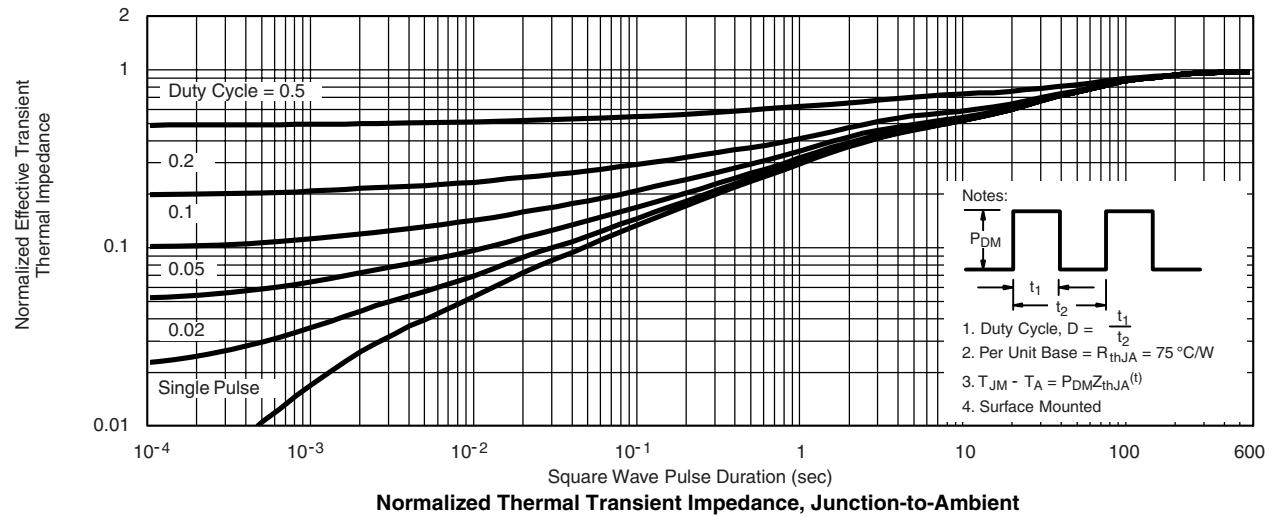
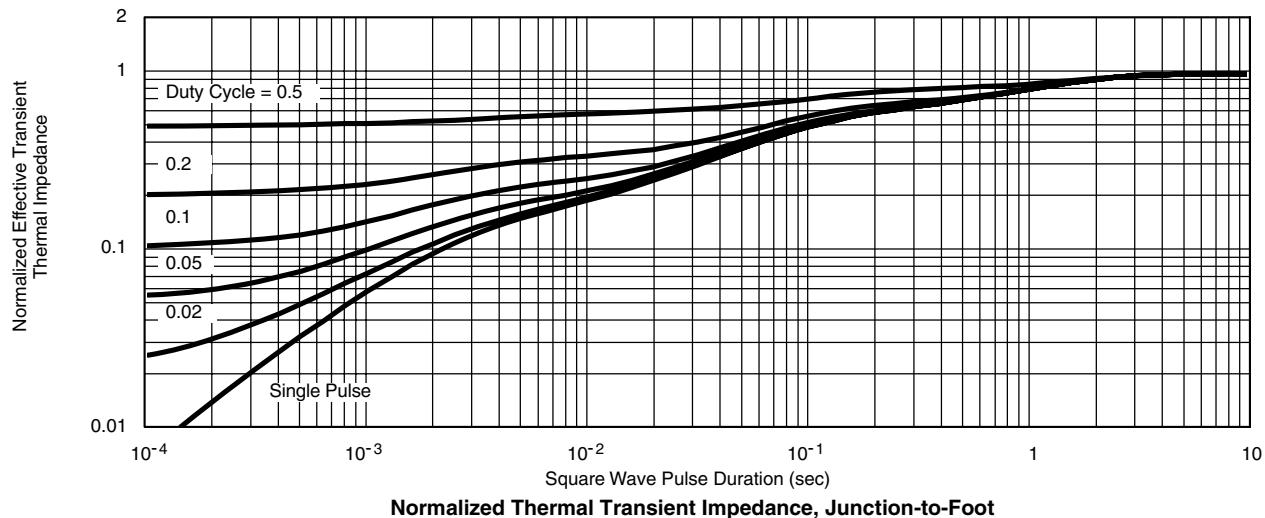
b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

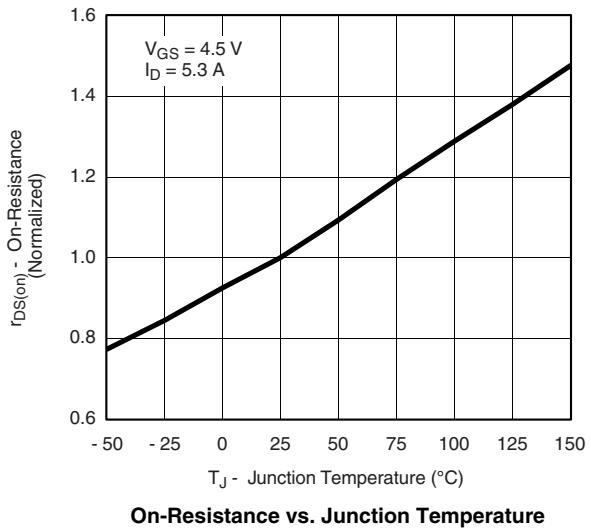
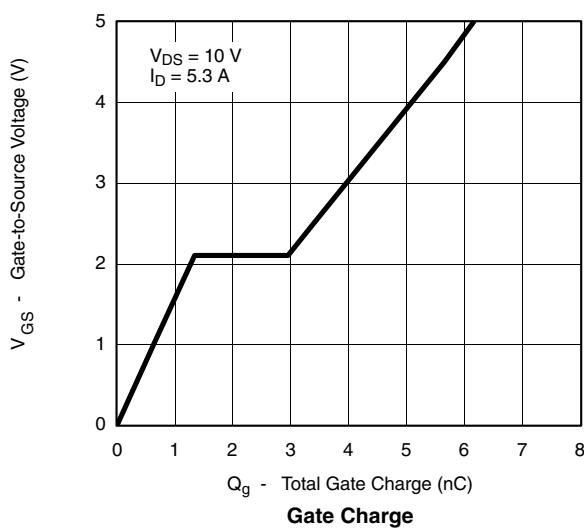
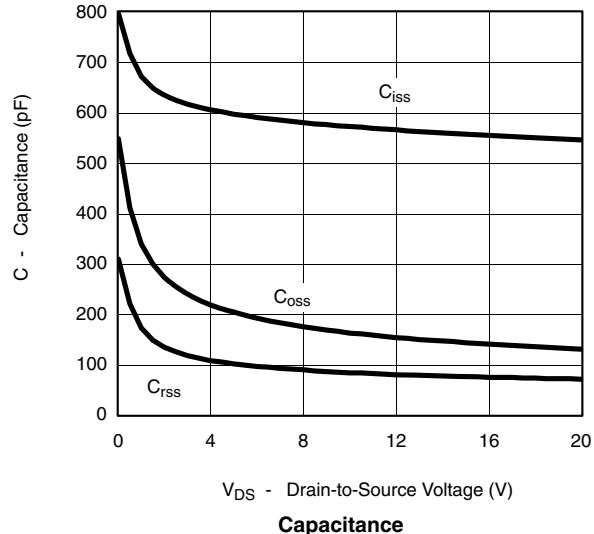
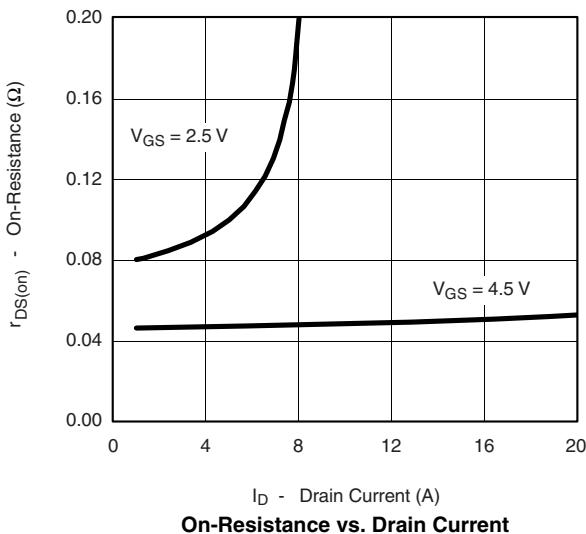
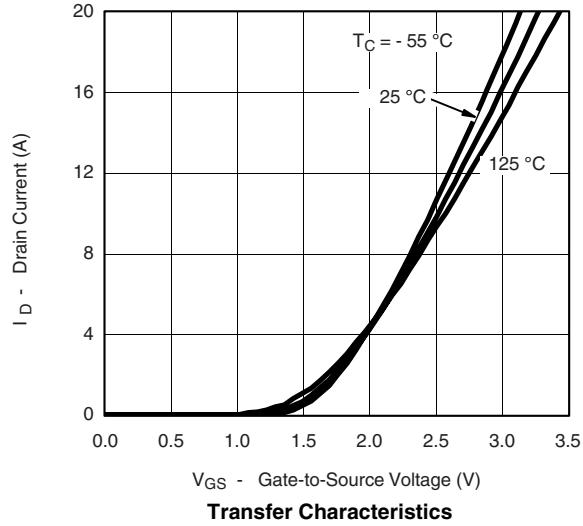
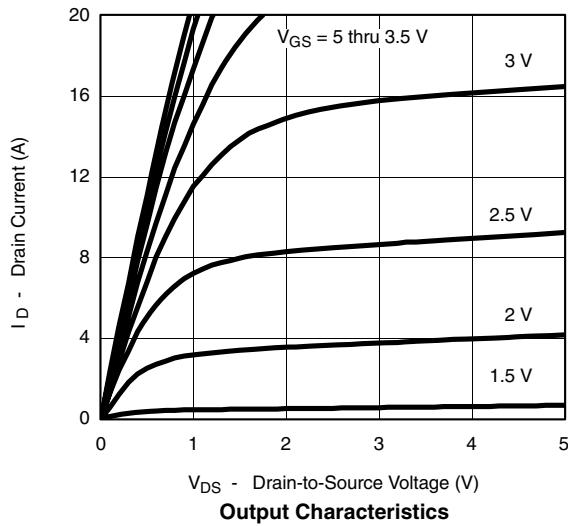
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

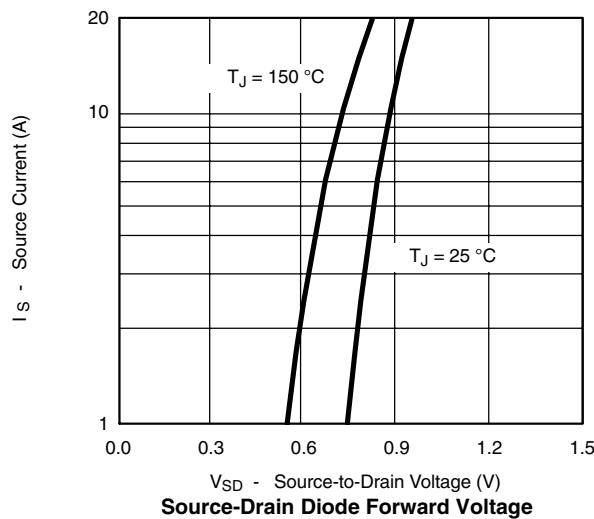
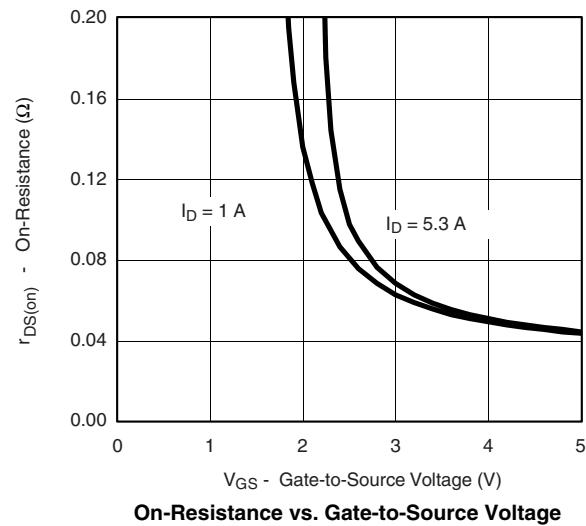
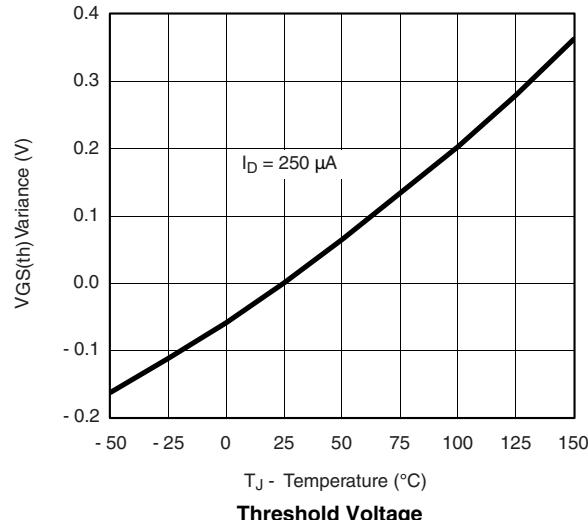
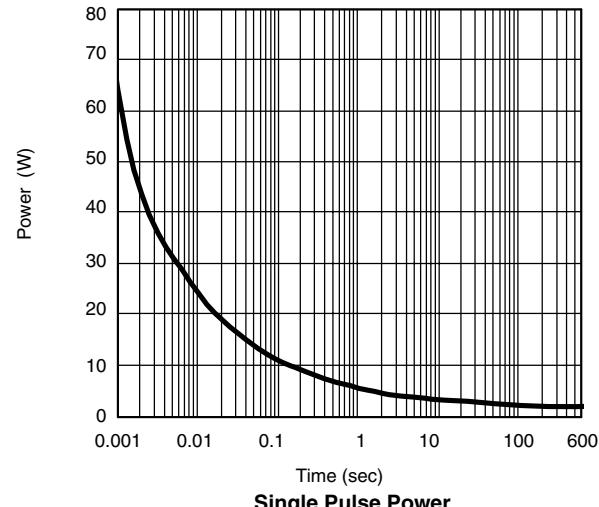
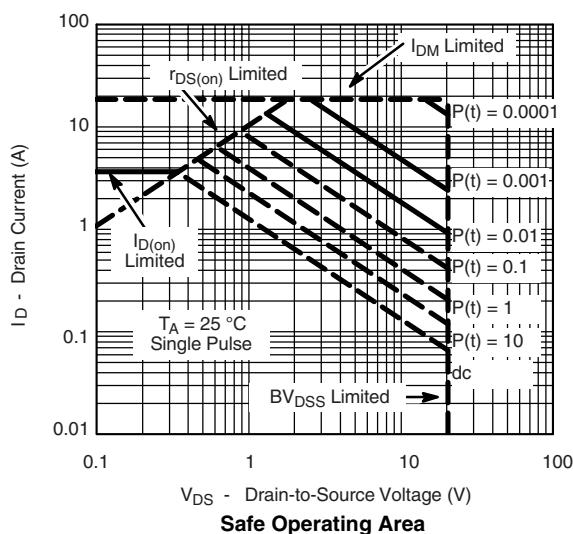
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless noted


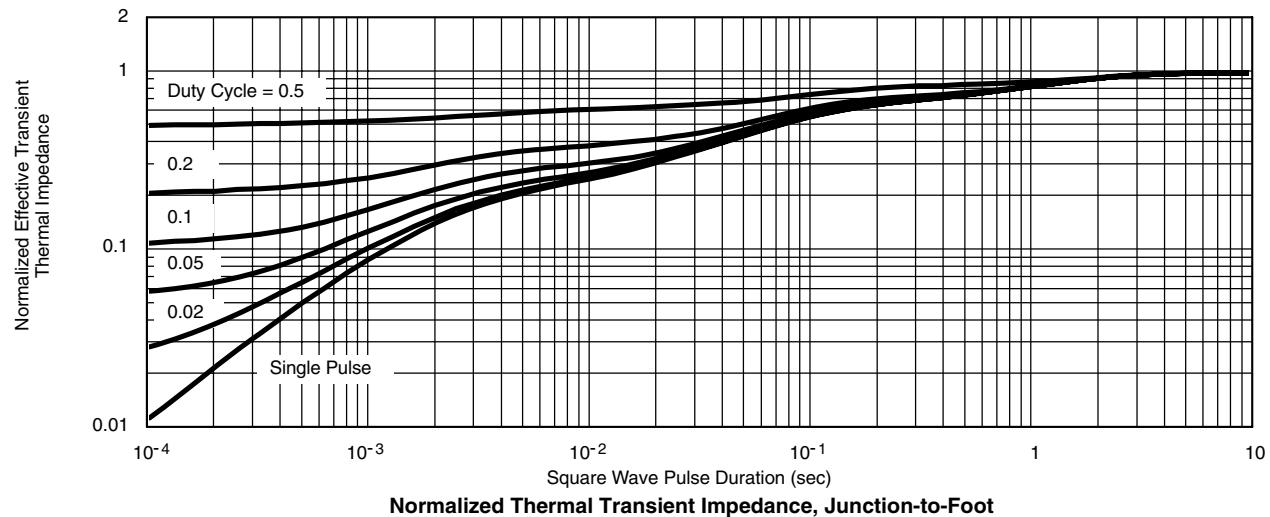
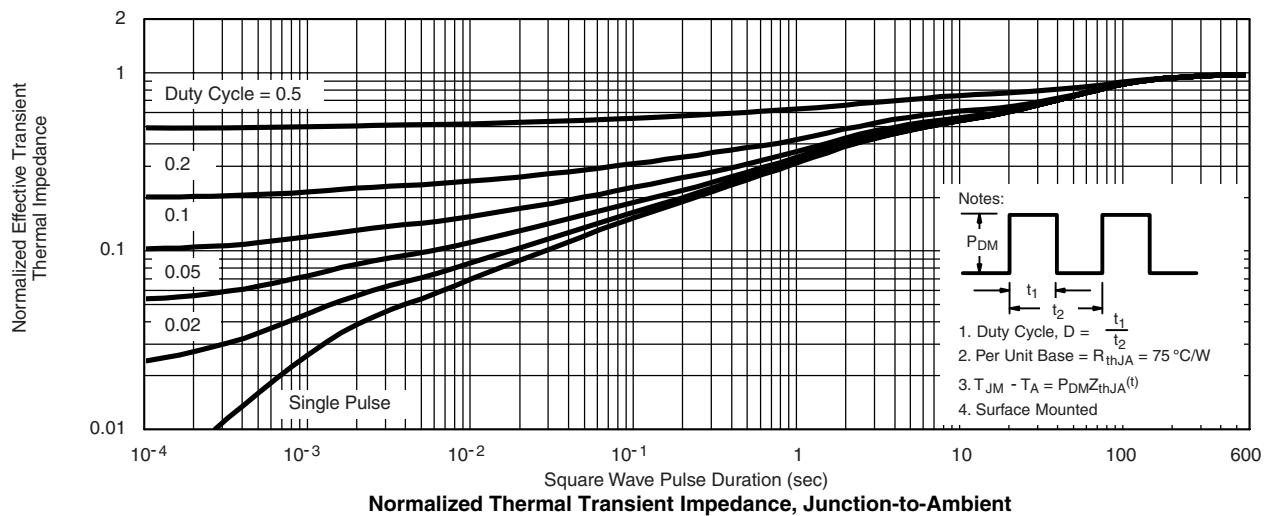
### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless noted

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Foot**

**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless noted

**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless noted

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Single Pulse Power**

**Safe Operating Area**

**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless noted

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## Legal Disclaimer Notice

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